

## SN74LVC1G79 单路正缘触发 D 型触发器

### 1 特性

- 采用德州仪器 (TI) 的 NanoFree™ 封装
- 锁断性能超过 100mA, 符合 JESD 78 II 类规范的要求
- 静电放电 (ESD) 保护性能超过 JESD 22 规范的要求
  - 2000V 人体放电模型 (A114-A)
  - 200V 机器放电模式 (A115-A)
  - 1000V 组件充电模式 (C101)
- 支持 5V  $V_{CC}$  运行
- 输入接受的电压达到高达 5.5V
- 支持向下转换到  $V_{CC}$
- 3.3V 和 50pF 负载下最大  $t_{pd}$  为 6ns
- 低功耗, 10 $\mu$ A 最大  $I_{CC}$
- 电压为 3.3V 时, 输出驱动为  $\pm 24$ mA
- $I_{off}$  支持部分断电模式和后驱动保护

### 2 应用

- 测试和测量
- 企业交换
- 电信基础设施
- 个人电子产品
- 白色家电

### 3 说明

SN74LVC1G79 器件是一种的单路正缘触发 D 型触发器, 专门为 1.65V 到 5.5V  $V_{CC}$  操作而设计。

当数据输入 (D) 处的数据满足设置时间要求时, 将该数据传输到时钟脉冲正向缘上的 Q 输出。时钟触发出现在一个特定电压电平上, 并且不与时钟脉冲的上升时间直接相关。经过保持时间间隔后, 可以更改 D 输入处的数据而不影响输出处的电平。

NanoFree™ 封装技术是 IC 封装概念的一项重大突破, 它将硅晶片用作封装。

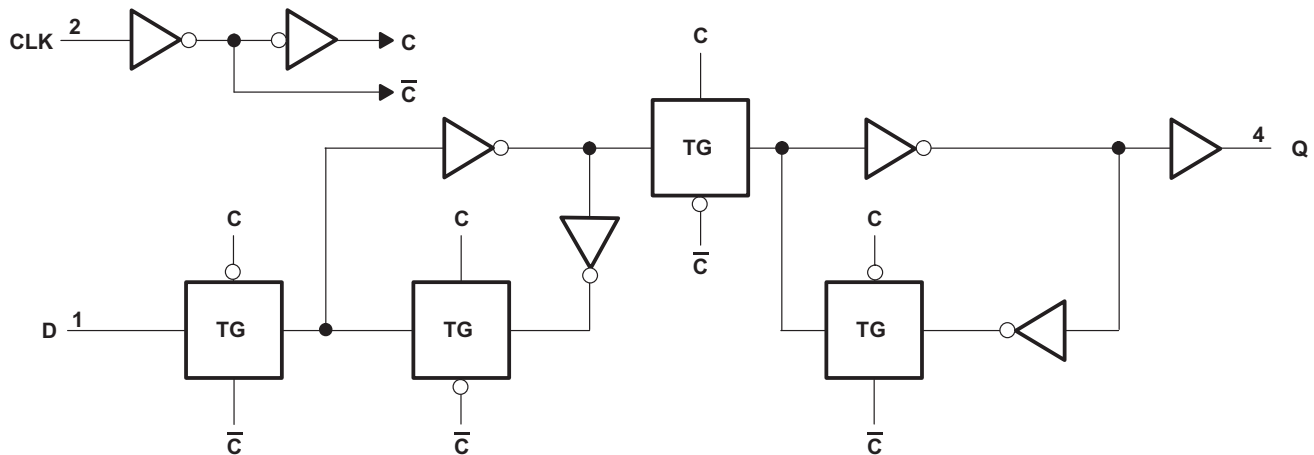
该器件完全适用于使用  $I_{off}$  的局部掉电应用。当器件断电时,  $I_{off}$  电路将会禁用输出。这会抑制电流反流到器件中, 从而防止损坏器件。

器件信息<sup>(1)</sup>

| 器件型号           | 封装         | 封装尺寸            |
|----------------|------------|-----------------|
| SN74LVC1G79DBV | SOT-23 (5) | 2.90mm × 1.60mm |
| SN74LVC1G79DCK | SC70 (5)   | 2.00mm × 1.25mm |
| SN74LVC1G79DRL | SOT (5)    | 1.60mm × 1.20mm |
| SN74LVC1G79YZP | DSBGA (5)  | 1.14mm × 0.91mm |

(1) 要了解所有可用封装, 请参见数据表末尾的可订购产品附录。

逻辑图 (正逻辑)



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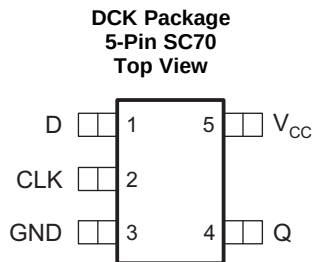
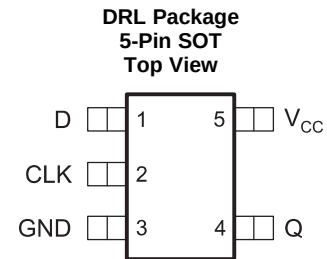
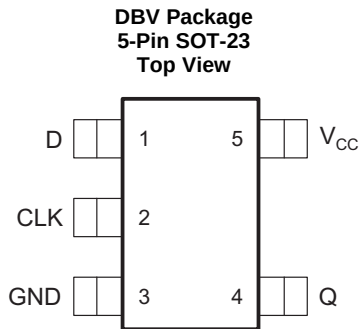
## 4 修订历史记录

注：之前版本的页码可能与当前版本有所不同。

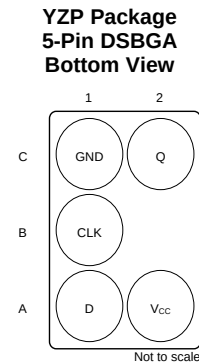
| Changes from Revision T (December 2013) to Revision U                                                    | Page |
|----------------------------------------------------------------------------------------------------------|------|
| • 已添加 器件信息 表、ESD 额定值 表、热性能信息 表、特性 说明 部分、器件功能模式、应用和实施 部分、电源相关建议 部分、布局 部分、器件和文档支持 部分以及机械、封装和可订购信息 部分 ..... | 1    |
| • Changed thermal information to align with JEDEC standards. ....                                        | 5    |

| Changes from Revision S (November 2007) to Revision T | Page |
|-------------------------------------------------------|------|
| • 将文档更新为了新的 TI 数据表格式。 ....                            | 1    |
| • 删除了订购信息表。 ....                                      | 1    |
| • 更新了 $I_{\text{off}}$ 特性。 ....                       | 1    |
| • Updated operating temperature range. ....           | 5    |
| • 添加了 ESD 警告。 ....                                    | 15   |

## 5 Pin Configuration and Functions



See mechanical drawings for dimensions.



### Pin Functions

| NAME            | PIN           |     | I/O | DESCRIPTION                         |
|-----------------|---------------|-----|-----|-------------------------------------|
|                 | DBV, DCK, DRL | YZP |     |                                     |
| D               | 1             | A1  | I   | Data input                          |
| CLK             | 2             | B1  | I   | Positive-Edge-Triggered Clock input |
| GND             | 3             | C1  | —   | Ground                              |
| Q               | 4             | C2  | O   | Non-inverted output                 |
| V <sub>CC</sub> | 5             | A2  | —   | Positive Supply                     |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |                                                                                             |                    | MIN  | MAX                   | UNIT |
|------------------|---------------------------------------------------------------------------------------------|--------------------|------|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage                                                                              |                    | −0.5 | 6.5                   | V    |
| V <sub>I</sub>   | Input voltage <sup>(2)</sup>                                                                |                    | −0.5 | 6.5                   | V    |
| V <sub>O</sub>   | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> |                    | −0.5 | 6.5                   | V    |
| V <sub>O</sub>   | Voltage range applied to any output in the high or low state <sup>(2)(3)</sup>              |                    | −0.5 | V <sub>CC</sub> + 0.5 | V    |
| I <sub>IK</sub>  | Input clamp current                                                                         | V <sub>I</sub> < 0 | −50  |                       | mA   |
| I <sub>OK</sub>  | Output clamp current                                                                        | V <sub>O</sub> < 0 | −50  |                       | mA   |
| I <sub>O</sub>   | Continuous output current                                                                   |                    | ±50  |                       | mA   |
|                  | Continuous current through V <sub>CC</sub> or GND                                           |                    | ±100 |                       | mA   |
| T <sub>stg</sub> | Storage temperature                                                                         |                    | −65  | 150                   | °C   |
| T <sub>J</sub>   | Junction temperature                                                                        |                    |      | 150                   | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of  $V_{CC}$  is provided in the *Recommended Operating Conditions* table.

### 6.2 ESD Ratings

|             |                         | VALUE                                                                          | UNIT  |
|-------------|-------------------------|--------------------------------------------------------------------------------|-------|
| $V_{(ESD)}$ | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 |
|             |                         | Charged device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000 |
|             |                         | Machine Model (MM), A115-A                                                     | 200   |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                 |                                    | MIN                                             | MAX                    | UNIT |
|-----------------|------------------------------------|-------------------------------------------------|------------------------|------|
| V <sub>CC</sub> | Supply voltage                     | Operating                                       | 1.65                   | 5.5  |
|                 |                                    | Data retention only                             | 1.5                    |      |
| V <sub>IH</sub> | High-level input voltage           | V <sub>CC</sub> = 1.65 V to 1.95 V              | 0.65 × V <sub>CC</sub> | V    |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V                | 1.7                    |      |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V                  | 2                      |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V to 5.5 V                | 0.7 × V <sub>CC</sub>  |      |
| V <sub>IL</sub> | Low-level input voltage            | V <sub>CC</sub> = 1.65 V to 1.95 V              | 0.35 × V <sub>CC</sub> | V    |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V                | 0.7                    |      |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V                  | 0.8                    |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V to 5.5 V                | 0.3 × V <sub>CC</sub>  |      |
| V <sub>I</sub>  | Input voltage                      | 0                                               | 5.5                    | V    |
| V <sub>O</sub>  | Output voltage                     | 0                                               | V <sub>CC</sub>        | V    |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 1.65 V                        | –4                     | mA   |
|                 |                                    | V <sub>CC</sub> = 2.3 V                         | –8                     |      |
|                 |                                    | V <sub>CC</sub> = 3 V                           | –16                    |      |
|                 |                                    |                                                 | –24                    |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V                         | –32                    |      |
| I <sub>OL</sub> | Low-level output current           | V <sub>CC</sub> = 1.65 V                        | 4                      | mA   |
|                 |                                    | V <sub>CC</sub> = 2.3 V                         | 8                      |      |
|                 |                                    | V <sub>CC</sub> = 3 V                           | 16                     |      |
|                 |                                    |                                                 | 24                     |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V                         | 32                     |      |
| Δt/Δv           | Input transition rise or fall rate | V <sub>CC</sub> = 1.8 V ± 0.15 V, 2.5 V ± 0.2 V | 20                     | ns/V |
|                 |                                    | V <sub>CC</sub> = 3.3 V ± 0.3 V                 | 10                     |      |
|                 |                                    | V <sub>CC</sub> = 5 V ± 0.5 V                   | 5                      |      |
| T <sub>A</sub>  | Operating free-air temperature     | –40                                             | 125                    | °C   |

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. See [Implications of Slow or Floating CMOS Inputs](#), SCBA004.

### 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | SN74LVC1G79  |            |           |             | UNIT |
|-------------------------------|----------------------------------------------|--------------|------------|-----------|-------------|------|
|                               |                                              | DBV (SOT-23) | DCK (SC70) | DRL (SOT) | YZP (DSBGA) |      |
|                               |                                              | 5 PINS       | 5 PINS     | 5 PINS    | 5 PINS      |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 247.2        | 277.6      | 294.3     | 144.4       | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 154.5        | 179.5      | 129.9     | 1.3         | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 86.8         | 75.9       | 143.4     | 39.9        | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 58.0         | 49.7       | 14.3      | 0.5         | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 86.4         | 75.1       | 144.0     | 39.7        | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        |                           | TEST CONDITIONS                                                              | V <sub>CC</sub> | T <sub>A</sub> = –40°C to +85°C |                    |     | T <sub>A</sub> = –40°C to +125°C |                    |     | UNIT |
|------------------|---------------------------|------------------------------------------------------------------------------|-----------------|---------------------------------|--------------------|-----|----------------------------------|--------------------|-----|------|
|                  |                           |                                                                              |                 | MIN                             | TYP <sup>(1)</sup> | MAX | MIN                              | TYP <sup>(1)</sup> | MAX |      |
| V <sub>OH</sub>  | I <sub>OH</sub> = –100 μA |                                                                              | 1.65 V to 5.5 V | V <sub>CC</sub> – 0.1           |                    |     | V <sub>CC</sub> – 0.1            |                    |     | V    |
|                  | I <sub>OH</sub> = –4 mA   |                                                                              | 1.65 V          | 1.2                             |                    |     | 1.2                              |                    |     |      |
|                  | I <sub>OH</sub> = –8 mA   |                                                                              | 2.3 V           | 1.9                             |                    |     | 1.9                              |                    |     |      |
|                  | I <sub>OH</sub> = –16 mA  |                                                                              | 3 V             | 2.4                             |                    |     | 2.4                              |                    |     |      |
|                  | I <sub>OH</sub> = –24 mA  |                                                                              |                 | 2.3                             |                    |     | 2.3                              |                    |     |      |
|                  | I <sub>OH</sub> = –32 mA  |                                                                              | 4.5 V           | 3.8                             |                    |     | 3.8                              |                    |     |      |
| V <sub>OL</sub>  | I <sub>OL</sub> = 100 μA  |                                                                              | 1.65 V to 5.5 V | 0.1                             |                    |     | 0.1                              |                    |     | V    |
|                  | I <sub>OL</sub> = 4 mA    |                                                                              | 1.65 V          | 0.45                            |                    |     | 0.45                             |                    |     |      |
|                  | I <sub>OL</sub> = 8 mA    |                                                                              | 2.3 V           | 0.3                             |                    |     | 0.3                              |                    |     |      |
|                  | I <sub>OL</sub> = 16 mA   |                                                                              | 3 V             | 0.4                             |                    |     | 0.4                              |                    |     |      |
|                  | I <sub>OL</sub> = 24 mA   |                                                                              |                 | 0.55                            |                    |     | 0.55                             |                    |     |      |
|                  | I <sub>OL</sub> = 32 mA   |                                                                              | 4.5 V           | 0.55                            |                    |     | 0.55                             |                    |     |      |
| I <sub>I</sub>   | All inputs                | V <sub>I</sub> = 5.5 V or GND                                                | 0 to 5.5 V      | ±10                             |                    |     | ±5                               |                    |     | μA   |
| I <sub>off</sub> |                           | V <sub>I</sub> or V <sub>O</sub> = 5.5 V                                     | 0               | ±10                             |                    |     | ±10                              |                    |     | μA   |
| I <sub>CC</sub>  |                           | V <sub>I</sub> = 5.5 V or GND, I <sub>O</sub> = 0                            | 1.65 V to 5.5 V | 10                              |                    |     | 10                               |                    |     | μA   |
| ΔI <sub>CC</sub> |                           | One input at V <sub>CC</sub> – 0.6 V, Other inputs at V <sub>CC</sub> or GND | 3 V to 5.5 V    | 500                             |                    |     | 500                              |                    |     | μA   |
| C <sub>i</sub>   |                           | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 3.3 V           | 4                               |                    |     | 4                                |                    |     | pF   |

 (1) All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

## 6.6 Timing Requirements: T<sub>A</sub> = –40°C to +85°C

 over operating free-air temperature range (unless otherwise noted) (see [Figure 3](#))

| PARAMETER          |                                 |           | T <sub>A</sub> = –40°C to +85°C   |     |                                  |     |                                    |     |                                  |     | UNIT |
|--------------------|---------------------------------|-----------|-----------------------------------|-----|----------------------------------|-----|------------------------------------|-----|----------------------------------|-----|------|
|                    |                                 |           | V <sub>CC</sub> = 1.8<br>± 0.15 V |     | V <sub>CC</sub> = 2.5<br>± 0.2 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | V <sub>CC</sub> = 5 V<br>± 0.5 V |     |      |
|                    |                                 |           | MIN                               | MAX | MIN                              | MAX | MIN                                | MAX | MIN                              | MAX |      |
| f <sub>clock</sub> | Clock frequency                 |           | 160                               |     | 160                              |     | 160                                |     | 160                              |     | MHz  |
| t <sub>w</sub>     | Pulse duration, CLK high or low |           | 2.5                               |     | 2.5                              |     | 2.5                                |     | 2.5                              |     | ns   |
| t <sub>su</sub>    | Setup time before CLK↑          | Data high | 2.2                               |     | 1.4                              |     | 1.3                                |     | 1.2                              |     | ns   |
|                    |                                 | Data low  | 2.6                               |     | 1.4                              |     | 1.3                                |     | 1.2                              |     |      |
| t <sub>h</sub>     | Hold time, data after CLK↑      |           | 0.3                               |     | 0.4                              |     | 1                                  |     | 0.5                              |     | ns   |

## 6.7 Timing Requirements: T<sub>A</sub> = –40°C to +125°C

 over operating free-air temperature range (unless otherwise noted) (see [Figure 3](#))

| PARAMETER          |                                 |           | T <sub>A</sub> = –40°C to +125°C  |     |                                  |     |                                    |     |                                  |     | UNIT |
|--------------------|---------------------------------|-----------|-----------------------------------|-----|----------------------------------|-----|------------------------------------|-----|----------------------------------|-----|------|
|                    |                                 |           | V <sub>CC</sub> = 1.8<br>± 0.15 V |     | V <sub>CC</sub> = 2.5<br>± 0.2 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | V <sub>CC</sub> = 5 V<br>± 0.5 V |     |      |
|                    |                                 |           | MIN                               | MAX | MIN                              | MAX | MIN                                | MAX | MIN                              | MAX |      |
| f <sub>clock</sub> | Clock frequency                 |           | 160                               |     | 160                              |     | 160                                |     | 160                              |     | MHz  |
| t <sub>w</sub>     | Pulse duration, CLK high or low |           | 2.5                               |     | 2.5                              |     | 2.5                                |     | 2.5                              |     | ns   |
| t <sub>su</sub>    | Setup time before CLK↑          | Data high | 2.2                               |     | 1.4                              |     | 1.3                                |     | 1.2                              |     | ns   |
|                    |                                 | Data low  | 2.6                               |     | 1.4                              |     | 1.3                                |     | 1.2                              |     |      |
| t <sub>h</sub>     | Hold time, data after CLK↑      |           | 0.3                               |     | 0.4                              |     | 1                                  |     | 0.5                              |     | ns   |

### 6.8 Switching Characteristics: $C_L = 15 \text{ pF}$ , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$

over recommended operating free-air temperature range,  $C_L = 15 \text{ pF}$  (unless otherwise noted) (see [Figure 3](#))

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | T <sub>A</sub> = −40°C to +85°C     |     |                                    |     |                                    |     |                                  |     | UNIT |
|------------------|-----------------|----------------|-------------------------------------|-----|------------------------------------|-----|------------------------------------|-----|----------------------------------|-----|------|
|                  |                 |                | V <sub>CC</sub> = 1.8 V<br>± 0.15 V |     | V <sub>CC</sub> = 2.5 V<br>± 0.2 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | V <sub>CC</sub> = 5 V<br>± 0.5 V |     |      |
|                  |                 |                | MIN                                 | MAX | MIN                                | MAX | MIN                                | MAX | MIN                              | MAX |      |
| f <sub>max</sub> |                 |                | 160                                 |     | 160                                |     | 160                                |     | 160                              |     | MHz  |
| t <sub>pd</sub>  | CLK             | Q              | 2.5                                 | 9.1 | 1.2                                | 6   | 1                                  | 4   | 0.8                              | 3.8 | ns   |

### 6.9 Switching Characteristics: $C_L = 30$ or $50 \text{ pF}$ , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$

over recommended operating free-air temperature range,  $C_L = 30 \text{ pF}$  or  $50 \text{ pF}$  (unless otherwise noted) (see [Figure 4](#))

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | T <sub>A</sub> = −40°C to +85°C     |     |                                    |     |                                    |     |                                  |     | UNIT |
|------------------|-----------------|----------------|-------------------------------------|-----|------------------------------------|-----|------------------------------------|-----|----------------------------------|-----|------|
|                  |                 |                | V <sub>CC</sub> = 1.8 V<br>± 0.15 V |     | V <sub>CC</sub> = 2.5 V<br>± 0.2 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | V <sub>CC</sub> = 5 V<br>± 0.5 V |     |      |
|                  |                 |                | MIN                                 | MAX | MIN                                | MAX | MIN                                | MAX | MIN                              | MAX |      |
| f <sub>max</sub> |                 |                | 160                                 |     | 160                                |     | 160                                |     | 160                              |     | MHz  |
| t <sub>pd</sub>  | CLK             | Q              | 3.9                                 | 9.9 | 2                                  | 7   | 1.7                                | 5   | 1                                | 4.5 | ns   |

### 6.10 Switching Characteristics: $C_L = 30 \text{ pF}$ or $50 \text{ pF}$ , $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$

over recommended operating free-air temperature range,  $C_L = 30 \text{ pF}$  or  $50 \text{ pF}$  (unless otherwise noted) (see [Figure 4](#))

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | T <sub>A</sub> = −40°C to +125°C    |     |                                    |     |                                    |     |                                  |     | UNIT |
|------------------|-----------------|----------------|-------------------------------------|-----|------------------------------------|-----|------------------------------------|-----|----------------------------------|-----|------|
|                  |                 |                | V <sub>CC</sub> = 1.8 V<br>± 0.15 V |     | V <sub>CC</sub> = 2.5 V<br>± 0.2 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | V <sub>CC</sub> = 5 V<br>± 0.5 V |     |      |
|                  |                 |                | MIN                                 | MAX | MIN                                | MAX | MIN                                | MAX | MIN                              | MAX |      |
| f <sub>max</sub> |                 |                | 160                                 |     | 160                                |     | 160                                |     | 160                              |     | MHz  |
| t <sub>pd</sub>  | CLK             | Q              | 3.9                                 | 12  | 2                                  | 8.5 | 1.7                                | 6   | 1                                | 5   | ns   |

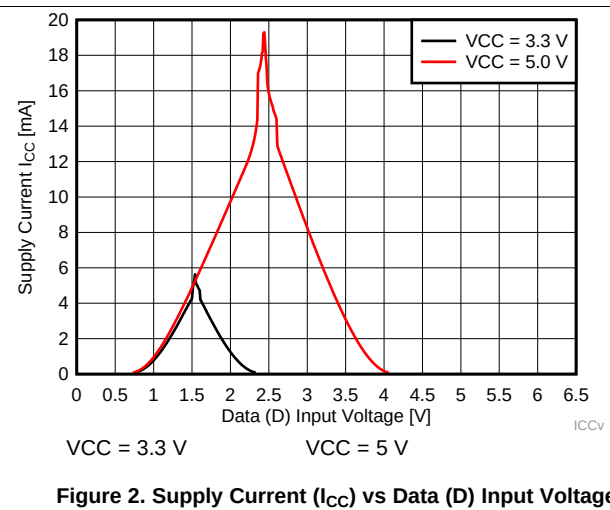
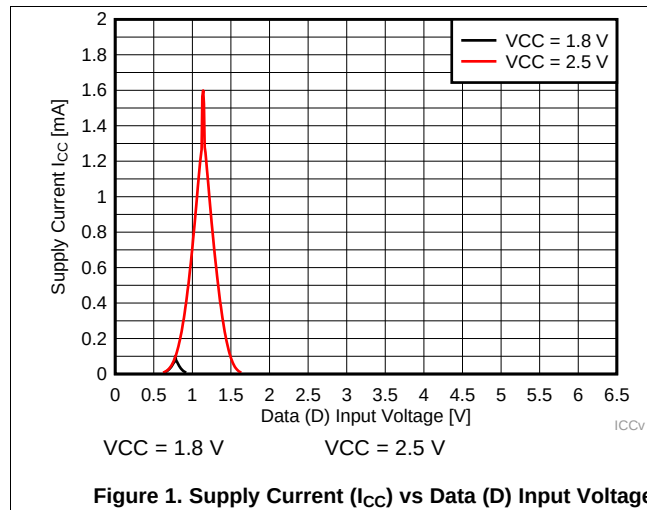
### 6.11 Operating Characteristics

$T_A = 25^\circ\text{C}$

| PARAMETER       | TEST<br>CONDITIONS            | $V_{CC} = 1.8 \text{ V}$ | $V_{CC} = 2.5 \text{ V}$ | $V_{CC} = 3.3 \text{ V}$ | $V_{CC} = 5 \text{ V}$ | UNIT |
|-----------------|-------------------------------|--------------------------|--------------------------|--------------------------|------------------------|------|
|                 |                               | TYP                      | TYP                      | TYP                      | TYP                    |      |
| $C_{\text{pd}}$ | Power dissipation capacitance | 26                       | 26                       | 27                       | 30                     | pF   |

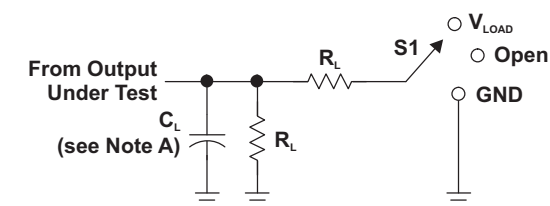
## 6.12 Typical Characteristics

This plot shows the different  $I_{CC}$  values for various voltages on the data input (D). Voltage sweep on the input is from 0 V to 6.5 V.





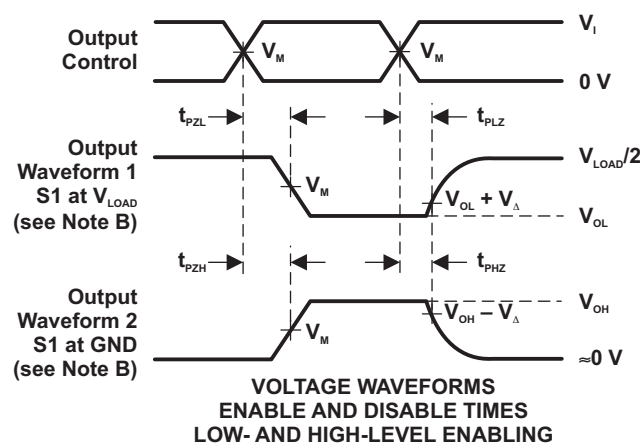
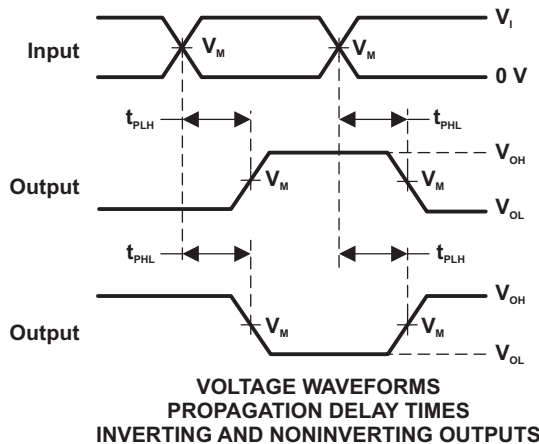
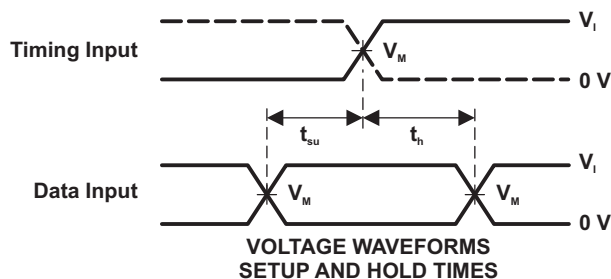
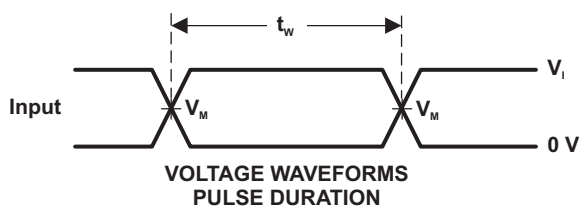
## 7 Parameter Measurement Information



LOAD CIRCUIT

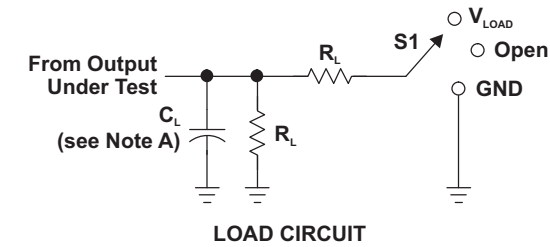
| TEST              | S1         |
|-------------------|------------|
| $t_{PLH}/t_{PHL}$ | Open       |
| $t_{PLZ}/t_{PZL}$ | $V_{LOAD}$ |
| $t_{PHZ}/t_{PZH}$ | GND        |

| $V_{CC}$                         | INPUTS   |                      | $V_M$      | $V_{LOAD}$        | $C_L$ | $R_L$        | $V_{\Delta}$ |
|----------------------------------|----------|----------------------|------------|-------------------|-------|--------------|--------------|
|                                  | $V_I$    | $t_f/t_r$            |            |                   |       |              |              |
| $1.8\text{ V} \pm 0.15\text{ V}$ | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 15 pF | 1 M $\Omega$ | 0.15 V       |
| $2.5\text{ V} \pm 0.2\text{ V}$  | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 15 pF | 1 M $\Omega$ | 0.15 V       |
| $3.3\text{ V} \pm 0.3\text{ V}$  | 3 V      | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 15 pF | 1 M $\Omega$ | 0.3 V        |
| $5\text{ V} \pm 0.5\text{ V}$    | $V_{CC}$ | $\leq 2.5\text{ ns}$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 15 pF | 1 M $\Omega$ | 0.3 V        |



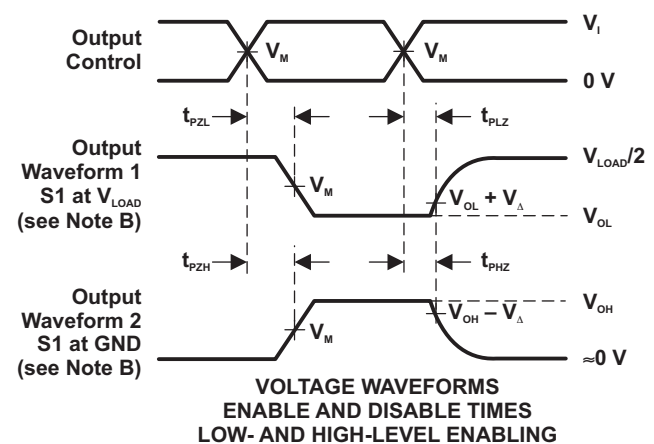
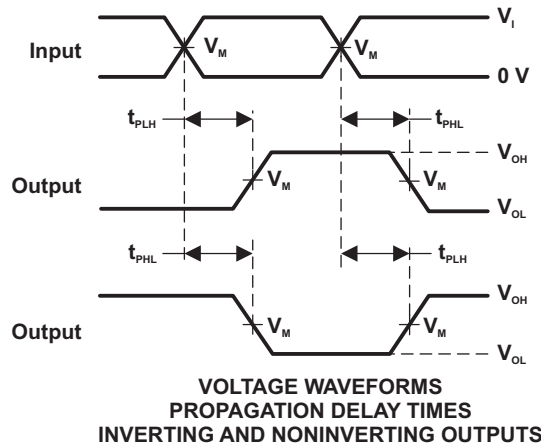
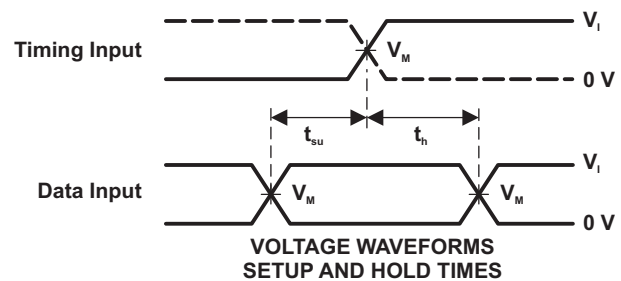
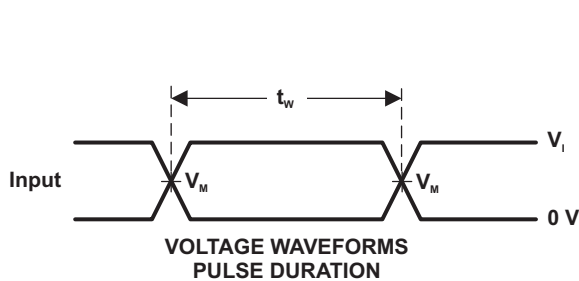
- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_o = 50\ \Omega$ .
  - D. The outputs are measured one at a time, with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - H. All parameters and waveforms are not applicable to all devices.

Figure 3. Load Circuit and Voltage Waveforms

**Parameter Measurement Information (continued)**


| TEST              | S1         |
|-------------------|------------|
| $t_{PLH}/t_{PHL}$ | Open       |
| $t_{PLZ}/t_{PZL}$ | $V_{LOAD}$ |
| $t_{PHZ}/t_{PZH}$ | GND        |

| $V_{CC}$                         | INPUTS   |                      | $V_M$      | $V_{LOAD}$        | $C_L$ | $R_L$        | $V_{\Delta}$ |
|----------------------------------|----------|----------------------|------------|-------------------|-------|--------------|--------------|
|                                  | $V_I$    | $t_r/t_f$            |            |                   |       |              |              |
| $1.8\text{ V} \pm 0.15\text{ V}$ | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 1 k $\Omega$ | 0.15 V       |
| $2.5\text{ V} \pm 0.2\text{ V}$  | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 500 $\Omega$ | 0.15 V       |
| $3.3\text{ V} \pm 0.3\text{ V}$  | 3 V      | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 50 pF | 500 $\Omega$ | 0.3 V        |
| $5\text{ V} \pm 0.5\text{ V}$    | $V_{CC}$ | $\leq 2.5\text{ ns}$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 50 pF | 500 $\Omega$ | 0.3 V        |



- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_o = 50\ \Omega$ .
  - The outputs are measured one at a time, with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{on}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - All parameters and waveforms are not applicable to all devices.

**Figure 4. Load Circuit and Voltage Waveforms**



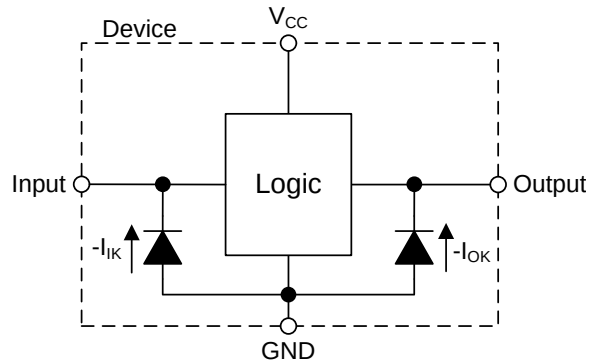
## Feature Description (continued)

### 8.3.3 Clamp Diodes

The inputs and outputs to this device have negative clamping diodes.

#### CAUTION

Voltages beyond the values specified in the [Absolute Maximum Ratings](#) table can cause damage to the device. The input negative-voltage and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.



**Figure 6. Electrical Placement of Clamping Diodes for Each Input and Output**

### 8.3.4 Partial Power Down ( $I_{off}$ )

The inputs and outputs for this device enter a high impedance state when the supply voltage is 0 V. The maximum leakage into or out of any input or output pin on the device is specified by  $I_{off}$  in the [Electrical Characteristics](#).

### 8.3.5 Over-Voltage Tolerant Inputs

Input signals to this device can be driven above the supply voltage so long as they remain below the maximum input voltage value specified in the [Absolute Maximum Ratings](#).

## 8.4 Device Functional Modes

[Table 1](#) lists the functional modes of SN74LVC1G79.

**Table 1. Function Table**

| INPUTS |   | OUTPUT<br>Y |
|--------|---|-------------|
| CLK    | D |             |
| ↑      | H | H           |
| ↑      | L | L           |
| L      | X | $Q_0$       |

## 9 Application and Implementation

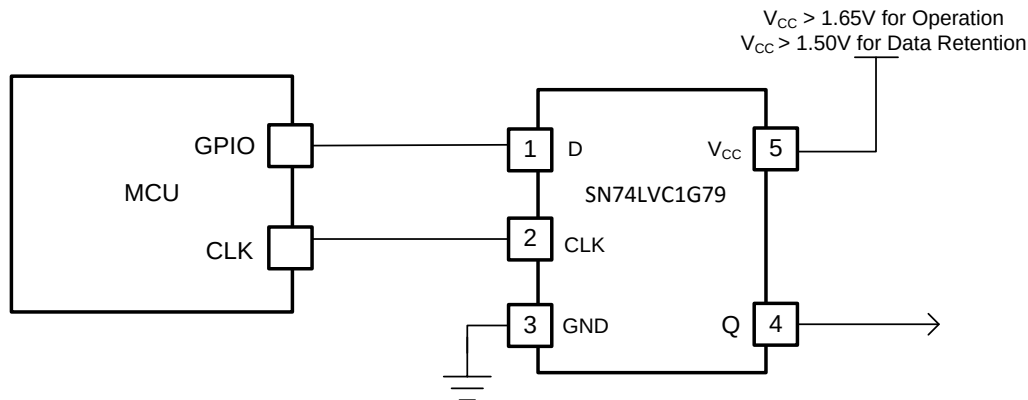
### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

A useful application for the SN74LVC1G79 is using it as a data latch with low-voltage data retention. This application implements the use of a microcontroller GPIO pin to act as a clock to set the output state and a second GPIO to provide the input data. If the SN74LVC1G79 is being powered from 1.8 V and there is concern that a power glitch could exist as low as 1.5 V, the device will retain the state of the Q output. An example of this data retention is shown in Figure 8 where the  $V_{CC}$  drops to 1.5 V and the Q output maintains the HIGH output state when  $V_{CC}$  returns to 1.8 V. If the  $V_{CC}$  voltage drops below 1.5 V, data retention is not guaranteed.

### 9.2 Typical Application



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**Figure 7. Low Voltage Data Retention With SN74LVC1G79**

#### 9.2.1 Design Requirements

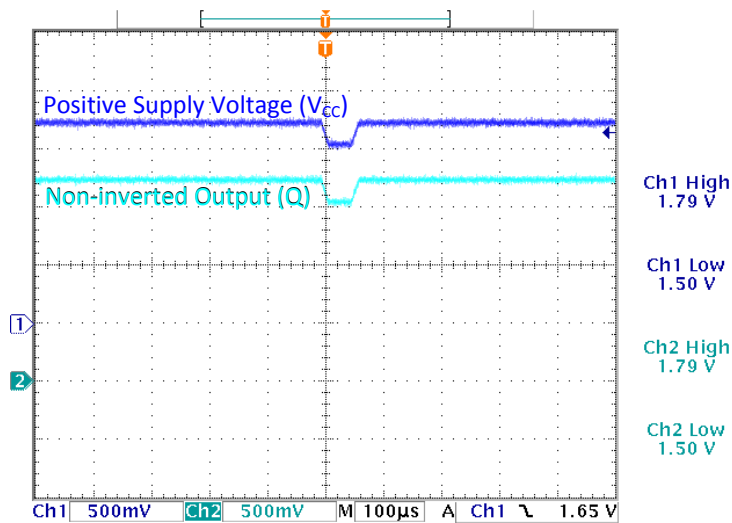
The SN74LVC1G79 device uses CMOS technology and has balanced output drive. Take care to avoid bus contention because it can drive currents that would exceed maximum limits.

#### 9.2.2 Detailed Design Procedure

1. Recommended input conditions:
  - For rise time and fall time specifications, see  $\Delta t/\Delta v$  in [Recommended Operating Conditions](#).
  - For specified high and low levels, see  $V_{IH}$  and  $V_{IL}$  in [Recommended Operating Conditions](#).
  - Input voltages are recommended to not go below 0 V and not exceed 5.5 V for any  $V_{CC}$ . See [Recommended Operating Conditions](#).
2. Recommended output conditions:
  - Load currents should not exceed  $\pm 50$  mA. See [Absolute Maximum Ratings](#).
  - Output voltages are recommended to not go below 0 V and not exceed the  $V_{CC}$  voltage. See [Recommended Operating Conditions](#).

## Typical Application (continued)

### 9.2.3 Application Curve



**Figure 8. Data Retention With  $V_{CC}$  Glitch Down to 1.5 V**

## 10 Power Supply Recommendations

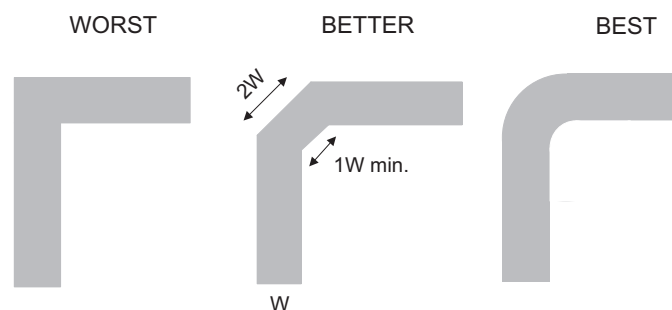
The power supply can be any voltage between the minimum and maximum supply voltage rating listed in [Recommended Operating Conditions](#). A 0.1- $\mu$ F bypass capacitor is recommended to be connected from the VCC terminal to GND to prevent power disturbance. To reject different frequencies of noise, use multiple bypass capacitors in parallel. Capacitors with values of 0.1  $\mu$ F and 1  $\mu$ F are commonly used in parallel. The bypass capacitor must be installed as close to the power terminal as possible for best results.

## 11 Layout

### 11.1 Layout Guidelines

When a PCB trace turns a corner at a 90° angle, a reflection can occur. A reflection occurs primarily because of the change of width of the trace. At the apex of the turn, the trace width increases to 1.414 times the width. This increase upsets the transmission-line characteristics, especially the distributed capacitance and self-inductance of the trace which results in the reflection. Not all PCB traces can be straight and therefore some traces must turn corners. [Figure 9](#) shows progressively better techniques of rounding corners. Only the last example (BEST) maintains constant trace width and minimizes reflections.

### 11.2 Layout Example



**Figure 9. Trace Example**

## 12 器件和文档支持

### 12.1 文档支持

#### 12.1.1 相关文档

相关文档请参阅以下部分：

- 《慢速或浮点 CMOS 输入的影响》，SCBA004
- 《了解和解读标准逻辑器件数据表》，SZZA036
- 《计时器件的加电行为》，SCHA005

### 12.2 接收文档更新通知

如需接收文档更新通知，请访问 [www.ti.com.cn](http://www.ti.com.cn) 网站上的器件产品文件夹。点击右上角的提醒我 (Alert me) 注册后，即可每周定期收到已更改的产品信息。有关更改的详细信息，请查阅已修订文档中包含的修订历史记录。

### 12.3 社区资源

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 12.4 商标

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### 12.5 静电放电警告



这些装置包含有限的内置 ESD 保护。存储或装卸时，应将导线一起截短或将装置放置于导电泡棉中，以防止 MOS 门极遭受静电损伤。

### 12.6 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 机械、封装和可订购信息

以下页中包括机械封装、封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对本文档进行修订的情况下发生改变。要获得这份数据表的浏览器版本，请查阅左侧导航栏。

## PACKAGING INFORMATION

| Orderable part number             | Status<br>(1) | Material type<br>(2) | Package   Pins    | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)      |
|-----------------------------------|---------------|----------------------|-------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|--------------------------|
| <a href="#">SN74LVC1G79DBVR</a>   | Active        | Production           | SOT-23 (DBV)   5  | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | (C795, C79F, C79J, C79R) |
| SN74LVC1G79DBVR.A                 | Active        | Production           | SOT-23 (DBV)   5  | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | (C795, C79F, C79J, C79R) |
| SN74LVC1G79DBVR.B                 | Active        | Production           | SOT-23 (DBV)   5  | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | (C795, C79F, C79J, C79R) |
| <a href="#">SN74LVC1G79DBVT</a>   | Active        | Production           | SOT-23 (DBV)   5  | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | (C795, C79F, C79J, C79R) |
| SN74LVC1G79DBVT.B                 | Active        | Production           | SOT-23 (DBV)   5  | 250   SMALL T&R       | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | (C795, C79F, C79J, C79R) |
| <a href="#">SN74LVC1G79DBVTG4</a> | Active        | Production           | SOT-23 (DBV)   5  | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C79F                     |
| SN74LVC1G79DBVTG4.B               | Active        | Production           | SOT-23 (DBV)   5  | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | C79F                     |
| <a href="#">SN74LVC1G79DCKR</a>   | Active        | Production           | SC70 (DCK)   5    | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | (CR5, CRF, CRJ, CR R)    |
| SN74LVC1G79DCKR.A                 | Active        | Production           | SC70 (DCK)   5    | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | (CR5, CRF, CRJ, CR R)    |
| SN74LVC1G79DCKR.B                 | Active        | Production           | SC70 (DCK)   5    | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | (CR5, CRF, CRJ, CR R)    |
| <a href="#">SN74LVC1G79DCKRG4</a> | Active        | Production           | SC70 (DCK)   5    | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | CR5                      |
| SN74LVC1G79DCKRG4.B               | Active        | Production           | SC70 (DCK)   5    | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | CR5                      |
| <a href="#">SN74LVC1G79DCKT</a>   | Active        | Production           | SC70 (DCK)   5    | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | (CR5, CRF, CRJ, CR R)    |
| SN74LVC1G79DCKT.B                 | Active        | Production           | SC70 (DCK)   5    | 250   SMALL T&R       | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | (CR5, CRF, CRJ, CR R)    |
| <a href="#">SN74LVC1G79DCKTG4</a> | Active        | Production           | SC70 (DCK)   5    | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | CR5                      |
| SN74LVC1G79DCKTG4.B               | Active        | Production           | SC70 (DCK)   5    | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | CR5                      |
| <a href="#">SN74LVC1G79DRLR</a>   | Active        | Production           | SOT-5X3 (DRL)   5 | 4000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-1-260C-UNLIM                | -40 to 125   | (CR7, CRR)               |
| SN74LVC1G79DRLR.A                 | Active        | Production           | SOT-5X3 (DRL)   5 | 4000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-1-260C-UNLIM                | -40 to 125   | (CR7, CRR)               |
| SN74LVC1G79DRLR.B                 | Active        | Production           | SOT-5X3 (DRL)   5 | 4000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-1-260C-UNLIM                | -40 to 125   | (CR7, CRR)               |
| <a href="#">SN74LVC1G79YZPR</a>   | Active        | Production           | DSBGA (YZP)   5   | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | (CR7, CRN)               |
| SN74LVC1G79YZPR.B                 | Active        | Production           | DSBGA (YZP)   5   | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | (CR7, CRN)               |



<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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#### OTHER QUALIFIED VERSIONS OF SN74LVC1G79 :

- Automotive : [SN74LVC1G79-Q1](#)
- Enhanced Product : [SN74LVC1G79-EP](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

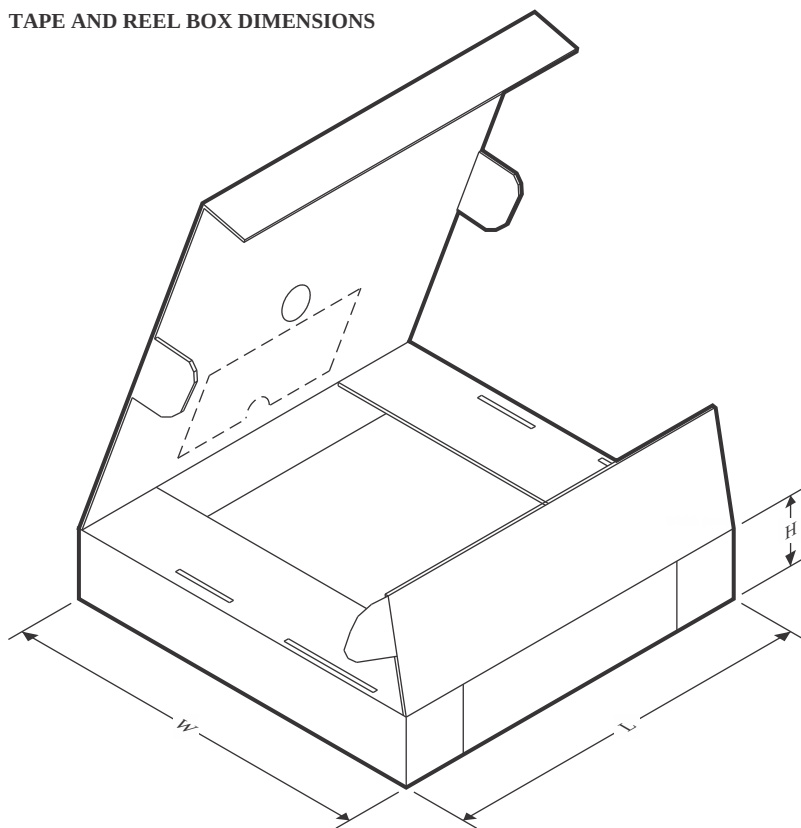
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LVC1G79DBVR   | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| SN74LVC1G79DBVT   | SOT-23       | DBV             | 5    | 250  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| SN74LVC1G79DBVT   | SOT-23       | DBV             | 5    | 250  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| SN74LVC1G79DBVTG4 | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| SN74LVC1G79DCKR   | SC70         | DCK             | 5    | 3000 | 178.0              | 8.4                | 2.25    | 2.45    | 1.2     | 4.0     | 8.0    | Q3            |
| SN74LVC1G79DCKR   | SC70         | DCK             | 5    | 3000 | 180.0              | 8.4                | 2.3     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| SN74LVC1G79DCKRG4 | SC70         | DCK             | 5    | 3000 | 178.0              | 9.2                | 2.4     | 2.4     | 1.22    | 4.0     | 8.0    | Q3            |
| SN74LVC1G79DCKT   | SC70         | DCK             | 5    | 250  | 180.0              | 8.4                | 2.3     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| SN74LVC1G79DCKTG4 | SC70         | DCK             | 5    | 250  | 178.0              | 9.2                | 2.4     | 2.4     | 1.22    | 4.0     | 8.0    | Q3            |
| SN74LVC1G79DRLR   | SOT-5X3      | DRL             | 5    | 4000 | 180.0              | 8.4                | 1.98    | 1.78    | 0.69    | 4.0     | 8.0    | Q3            |
| SN74LVC1G79YZPR   | DSBGA        | YZP             | 5    | 3000 | 178.0              | 9.2                | 1.02    | 1.52    | 0.63    | 4.0     | 8.0    | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVC1G79DBVR   | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| SN74LVC1G79DBVT   | SOT-23       | DBV             | 5    | 250  | 210.0       | 185.0      | 35.0        |
| SN74LVC1G79DBVT   | SOT-23       | DBV             | 5    | 250  | 210.0       | 185.0      | 35.0        |
| SN74LVC1G79DBVTG4 | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| SN74LVC1G79DCKR   | SC70         | DCK             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| SN74LVC1G79DCKR   | SC70         | DCK             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| SN74LVC1G79DCKRG4 | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74LVC1G79DCKT   | SC70         | DCK             | 5    | 250  | 210.0       | 185.0      | 35.0        |
| SN74LVC1G79DCKTG4 | SC70         | DCK             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| SN74LVC1G79DRLR   | SOT-5X3      | DRL             | 5    | 4000 | 202.0       | 201.0      | 28.0        |
| SN74LVC1G79YZPR   | DSBGA        | YZP             | 5    | 3000 | 220.0       | 220.0      | 35.0        |

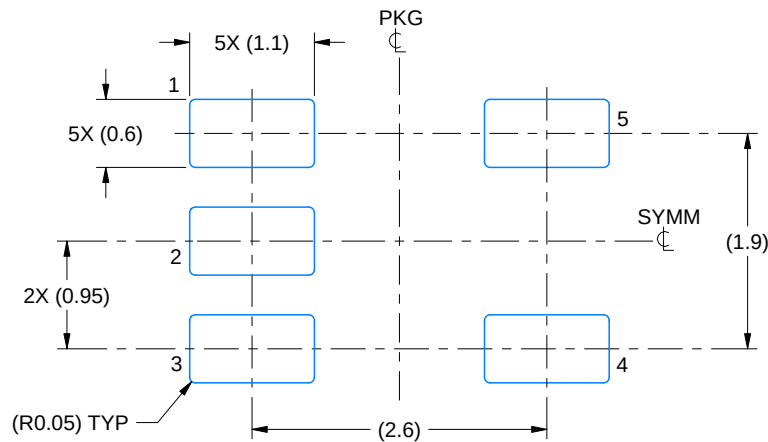


# EXAMPLE BOARD LAYOUT

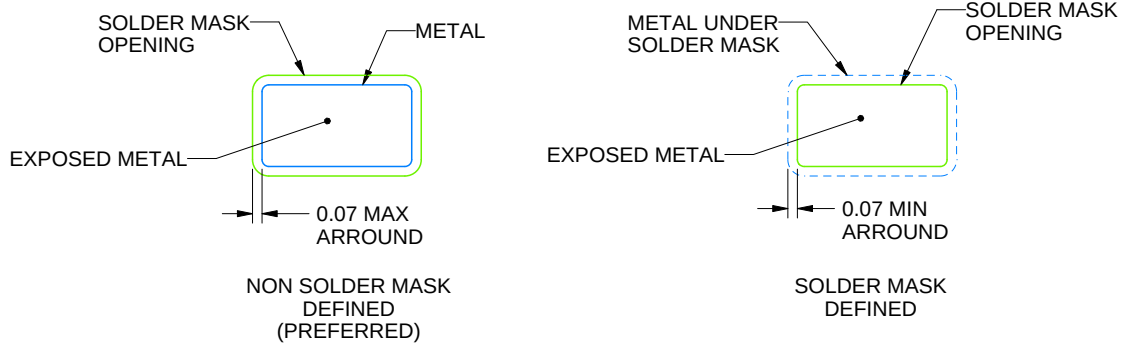
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/K 08/2024

NOTES: (continued)

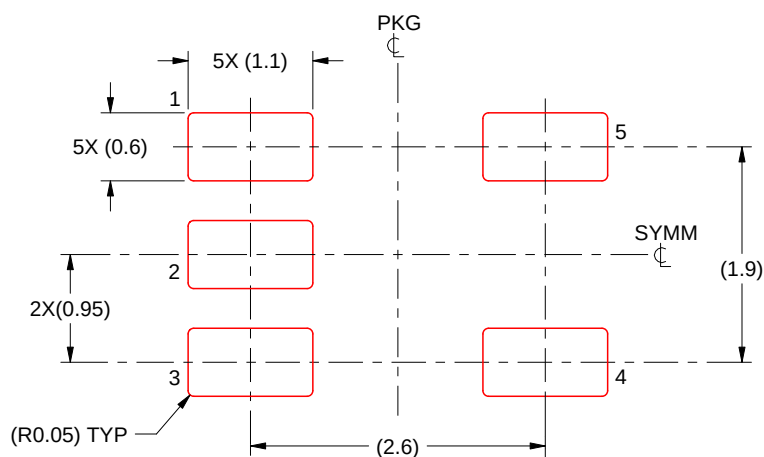
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4214839/K 08/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



**SOT - 0.6 mm max height**

[illegible]

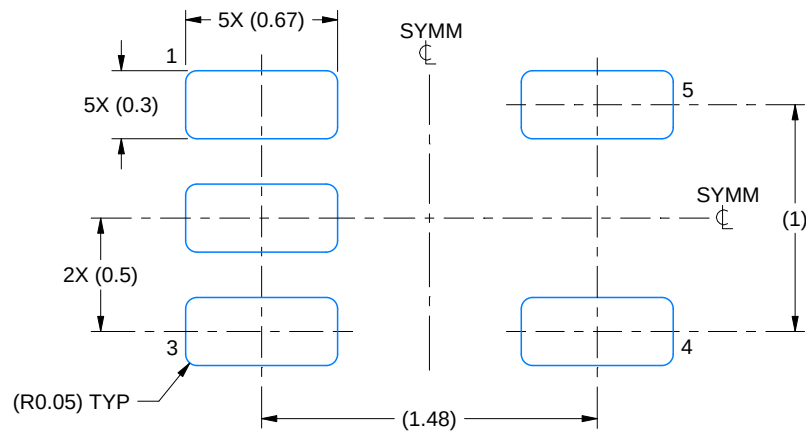
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-293 Variation UAAD-1

# EXAMPLE BOARD LAYOUT

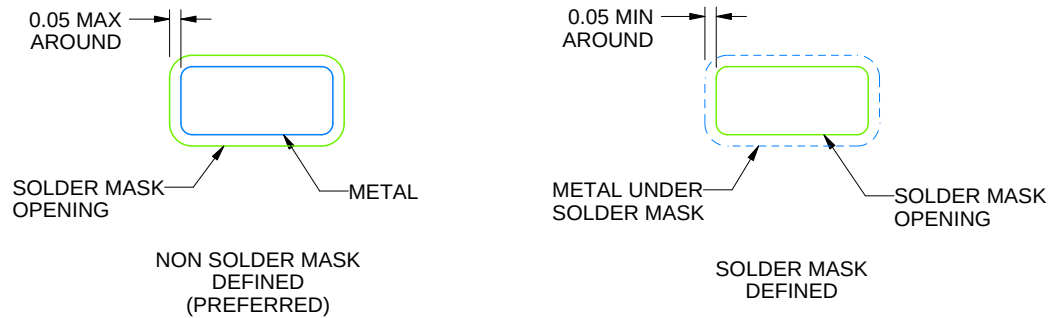
DRL0005A

SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



LAND PATTERN EXAMPLE  
SCALE:30X



SOLDERMASK DETAILS

4220753/E 11/2024

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

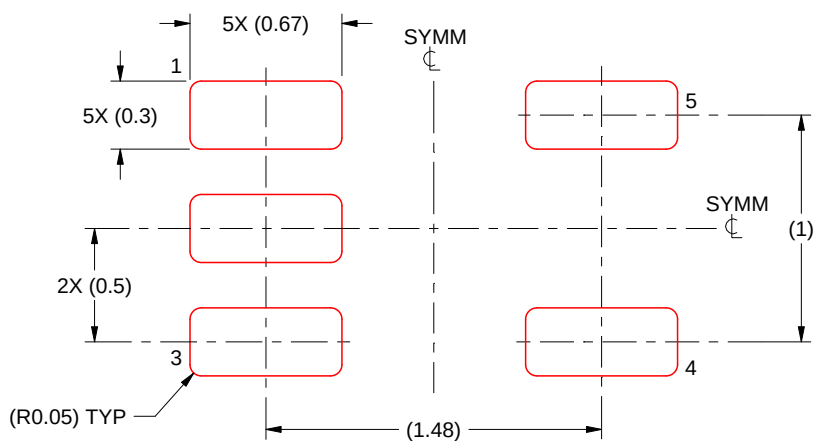


## EXAMPLE STENCIL DESIGN

DRL0005A

SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE:30X

4220753/E 11/2024

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

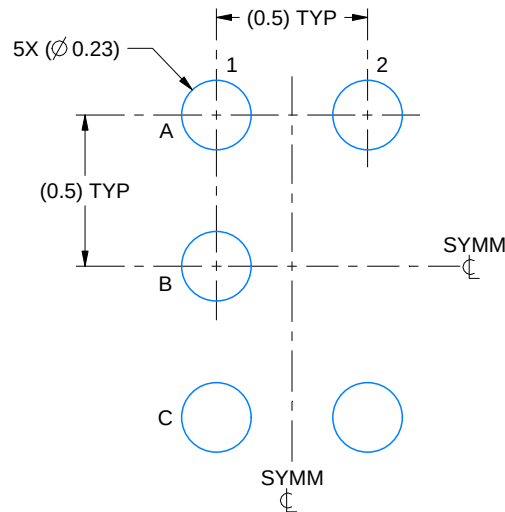


# EXAMPLE BOARD LAYOUT

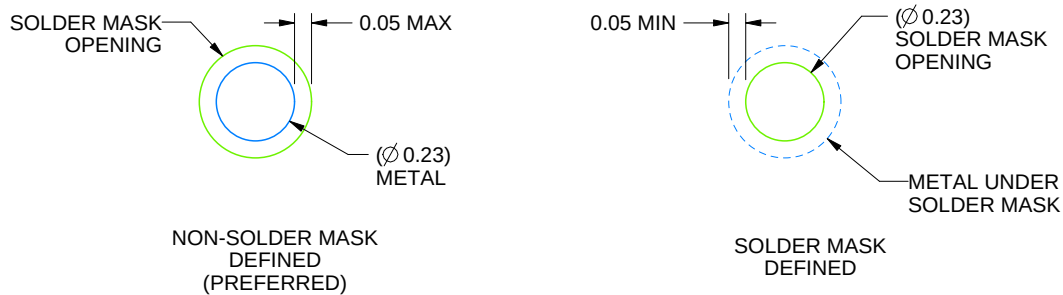
YZP0005

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



LAND PATTERN EXAMPLE  
SCALE:40X



SOLDER MASK DETAILS  
NOT TO SCALE

4219492/A 05/2017

NOTES: (continued)

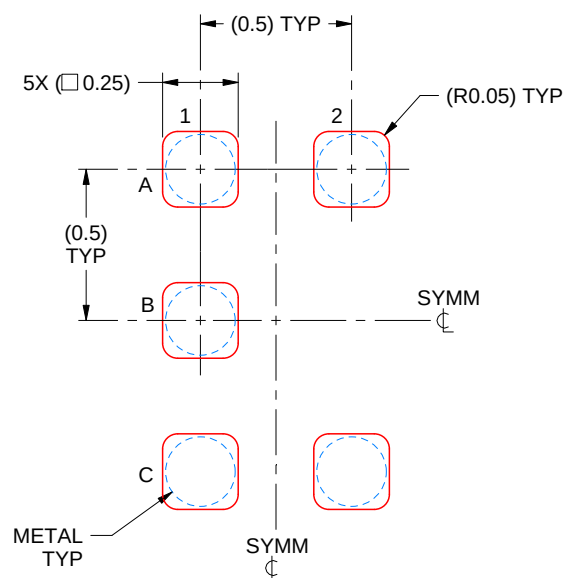
3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 ([www.ti.com/lit/snva009](http://www.ti.com/lit/snva009)).

## EXAMPLE STENCIL DESIGN

YZP0005

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY

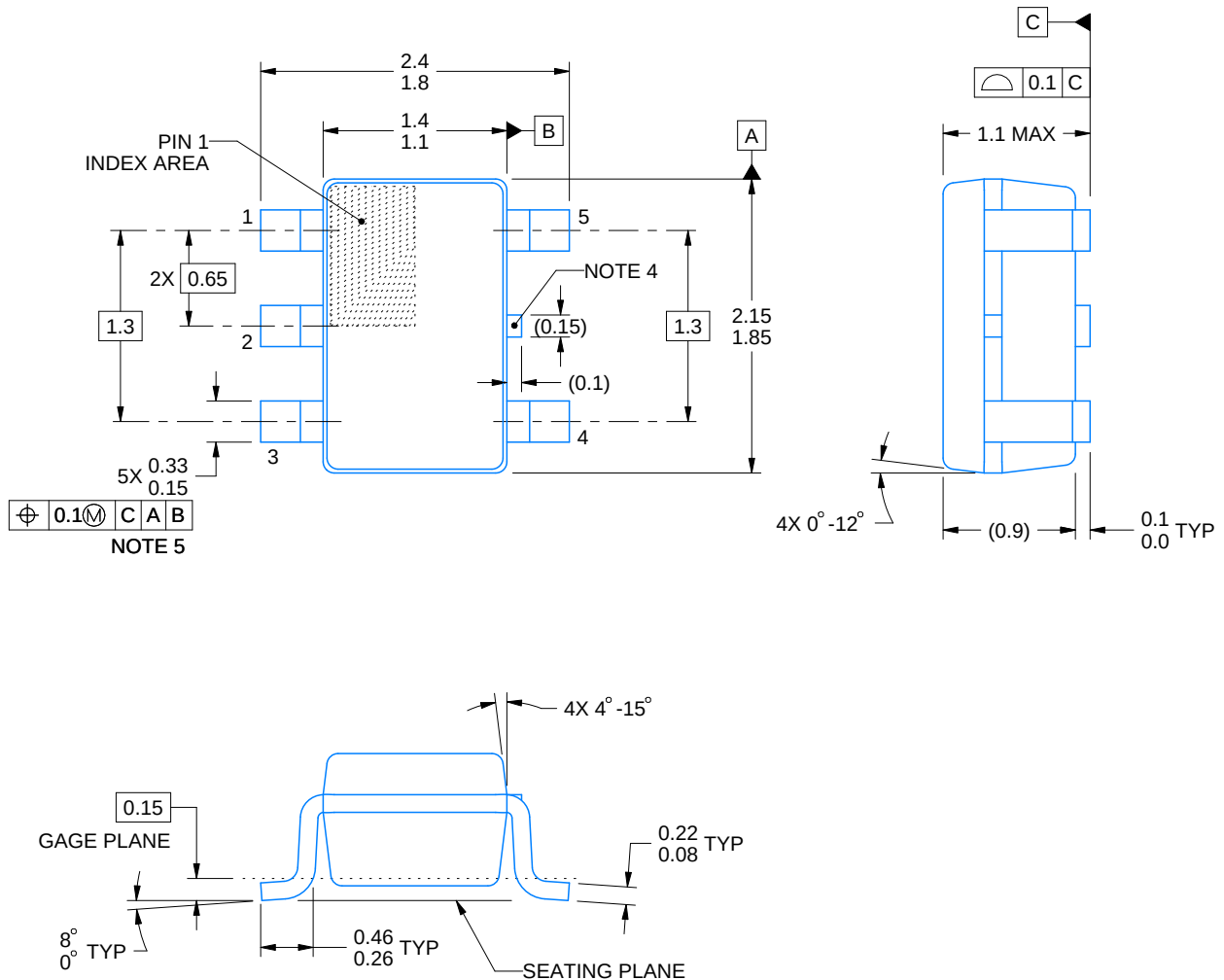


SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE:40X

4219492/A 05/2017

NOTES: (continued)

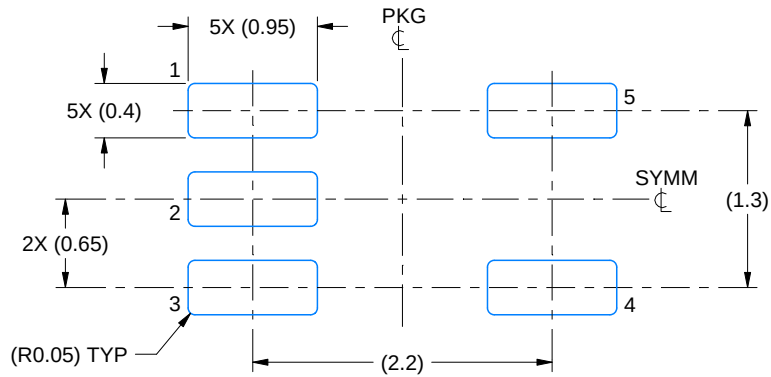
4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



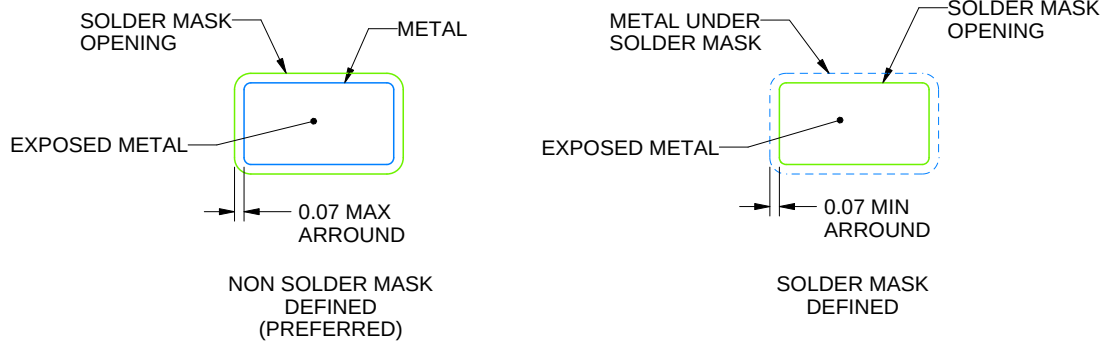
4214834/G 11/2024

## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-203.
4. Support pin may differ or may not be present.
5. Lead width does not comply with JEDEC.
6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:18X

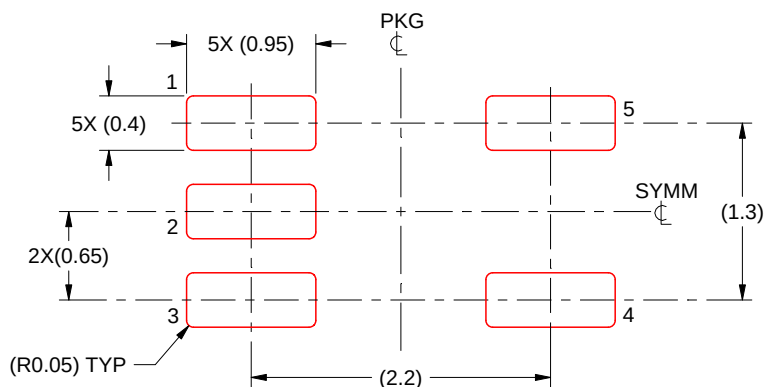


SOLDER MASK DETAILS

4214834/G 11/2024

NOTES: (continued)

7. Publication IPC-7351 may have alternate designs.
8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE  
 BASED ON 0.125 THICK STENCIL  
 SCALE:18X

4214834/G 11/2024

NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
10. Board assembly site may have different recommendations for stencil design.

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